

GSM4403

20V P-Channel Enhancement Mode MOSFET

Product Description

GSM4403, P-Channel enhancement mode MOSFET, uses Advanced Trench Technology to provide excellent $R_{DS(ON)}$, low gate charge.

These devices are particularly suited for low voltage power management, and low in-line power loss are needed in commercial industrial surface mount applications.

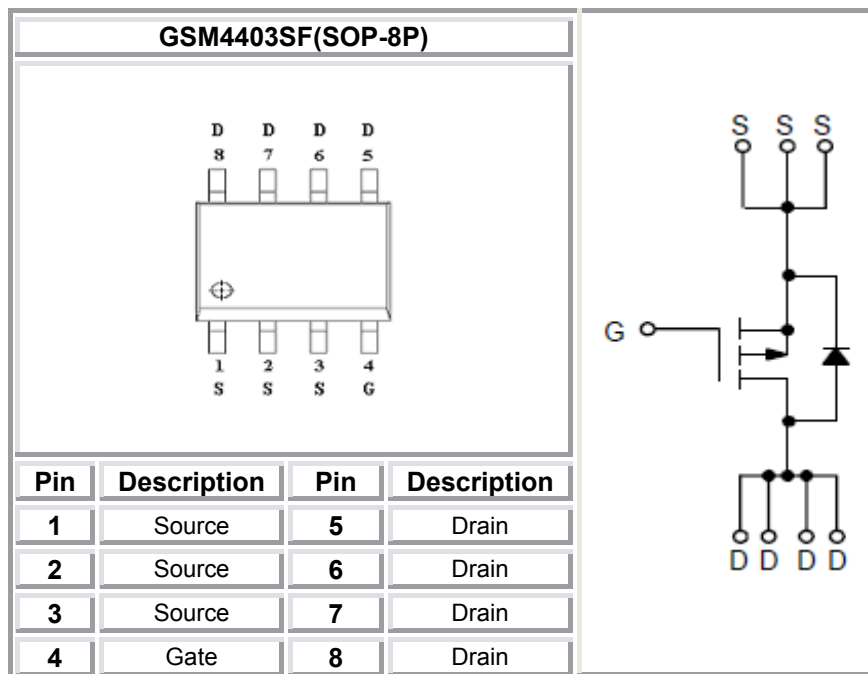
Features

- -20V/-9A, $R_{DS(ON)}=26m\Omega@V_{GS}=-4.5V$
- -20V/-8A, $R_{DS(ON)}=34m\Omega@V_{GS}=-2.5V$
- -20V/-6A, $R_{DS(ON)}=48m\Omega@V_{GS}=-1.8V$
- Super high density cell design for extremely low $R_{DS(ON)}$
- SOP-8P package design

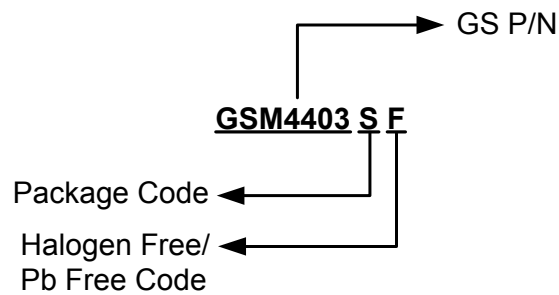
Applications

- LED Display
- Load Switch
- CCFL Inverter
- Power Management in Notebook Computer

Packages & Pin Assignments

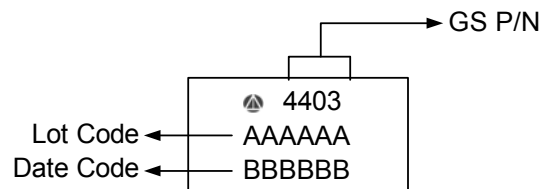


Ordering Information



Part Number	Package	Quantity Reel
GSM4403SF	SOP-8P	3000 PCS

Marking Information



Absolute Maximum Ratings

T_A=25°C unless otherwise noted

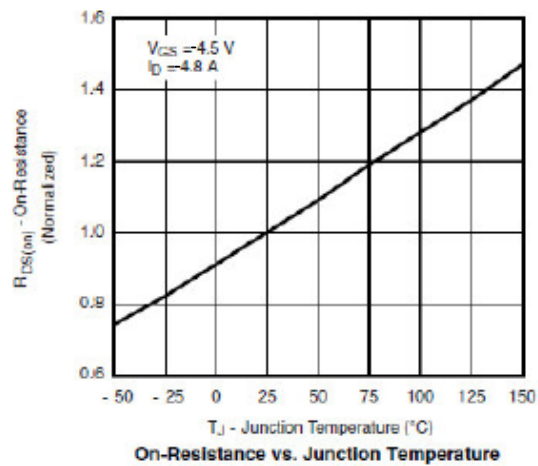
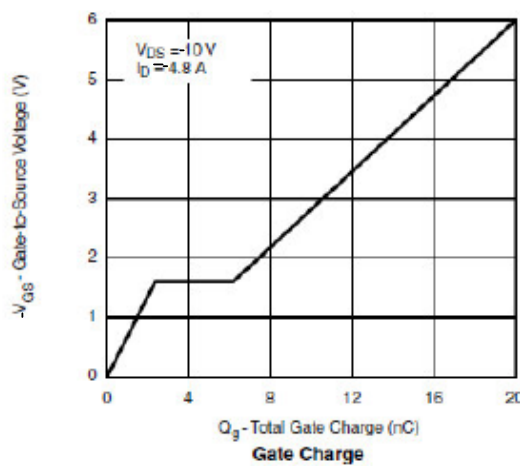
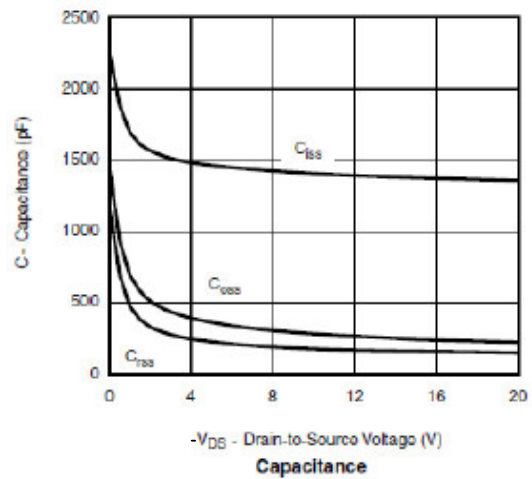
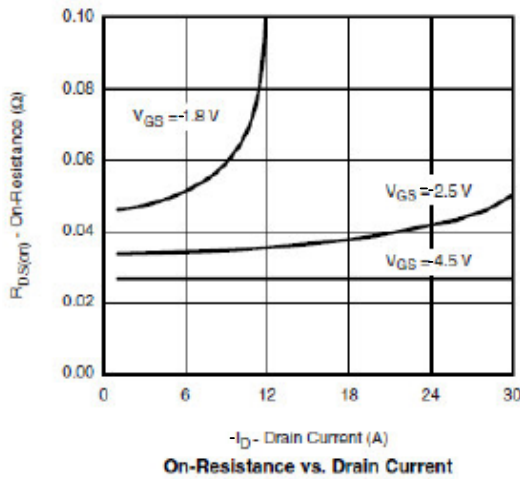
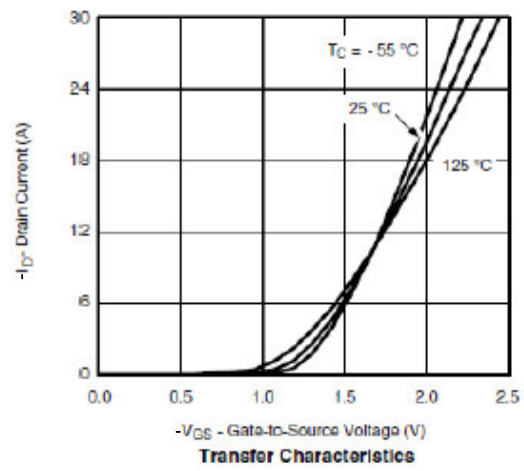
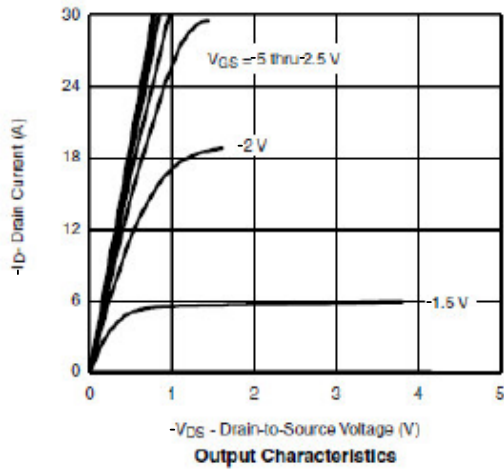
Symbol	Parameter	Typical	Unit
V _{DSS}	Drain-Source Voltage	-20	V
V _{GSS}	Gate –Source Voltage	±12	V
I _D	Continuous Drain Current(T _J =150°C)	T _A =25°C	-9.0
		T _A =70°C	-6.0
I _{DM}	Pulsed Drain Current	-40	A
I _S	Continuous Source-Drain Diode Current	-2	
P _D	Power Dissipation	T _A =25°C	2.8
		T _A =70°C	1.8
T _J	Operating Junction Temperature	150	°C
T _{STG}	Storage Temperature Range	-55/150	°C
R _{θJA}	Thermal Resistance-Junction to Ambient	62.5	°C/ W

Electrical Characteristics

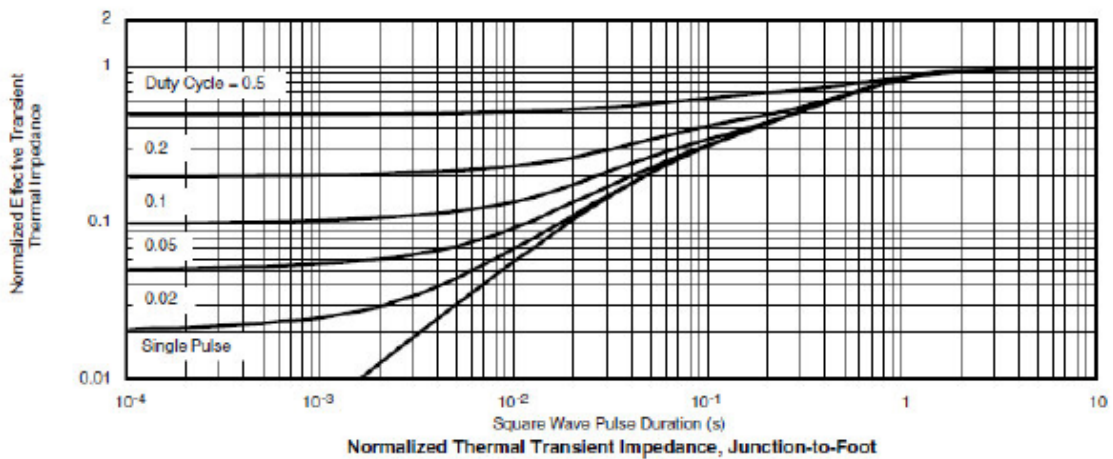
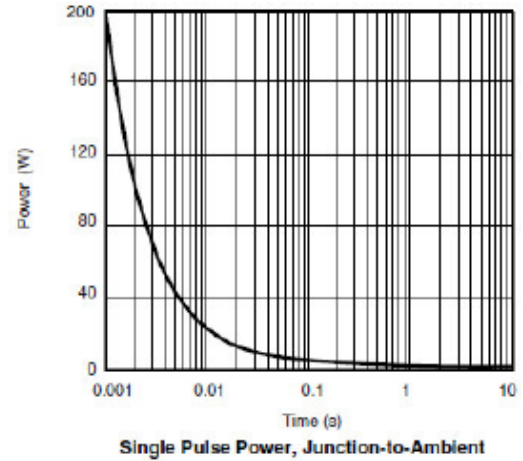
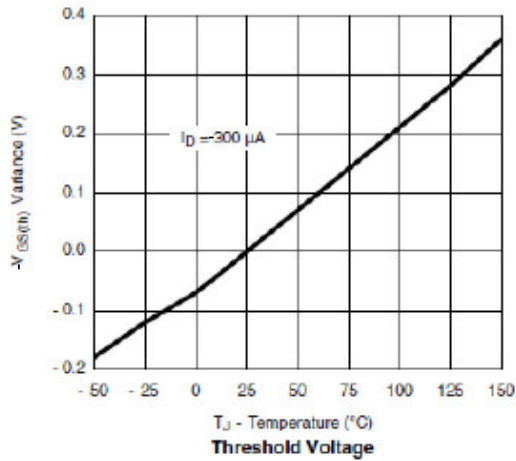
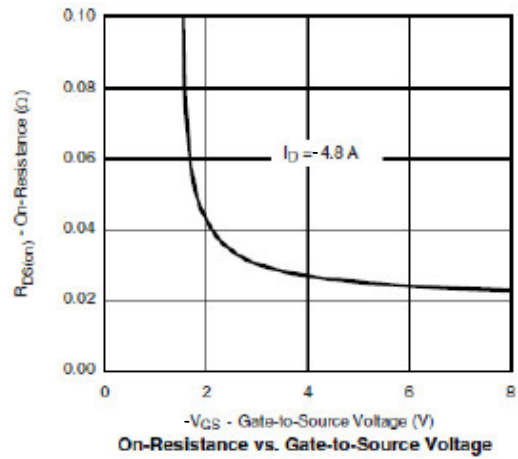
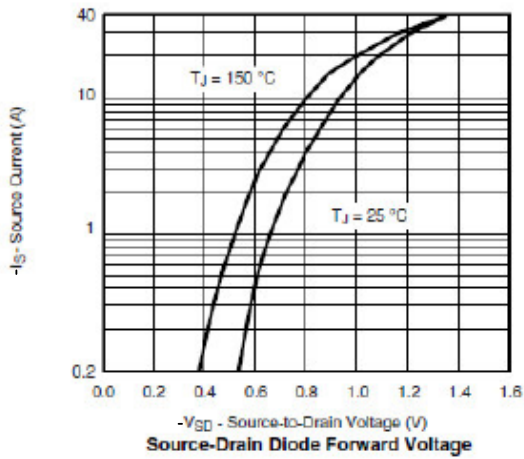
T_A=25°C unless otherwise noted

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
Static						
V _{(BR)DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =-250μA	-20			V
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =-250μA	-0.4		-0.9	
I _{GSS}	Gate Leakage Current	V _{DS} =0V, V _{GS} =±12V			±100	nA
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =-16V, V _{GS} =0V			-1	μA
		V _{DS} =-16V, V _{GS} =0V, T _J =85°C			-10	
I _{D(on)}	On-State Drain Current	V _{DS} ≤ -10V, V _{GS} =-10V	-30			A
		V _{DS} ≤ -5V, V _{GS} =-4.5V	-5			
R _{DS(on)}	Drain-Source On-Resistance	V _{GS} =-4.5V, I _D =-9.0A		18	26	mΩ
		V _{GS} =-2.5V, I _D =-8.0A		24	34	
		V _{GS} =-1.8V, I _D =-6.0A		38	48	
g _{FS}	Forward Transconductance	V _{DS} =-5V, I _D =-3.6A		10		S
V _{SD}	Diode Forward Voltage	I _S =-1.6A, V _{GS} =0V		-0.85	-1.2	V
Dynamic						
C _{iss}	Input Capacitance	V _{DS} =-10V, V _{GS} =0V, f=1MHz		1450		pF
C _{OSS}	Output Capacitance			350		
C _{rss}	Reverse Transfer Capacitance			215		
Q _g	Total Gate Charge	V _{DS} =-10V, V _{GS} =-5.0V, I _D =-4.8A		17	35	nC
Q _{gs}	Gate-Source Charge			2.5		
Q _{gd}	Gate-Drain Charge			5.0		
t _{d(on)}	Turn-On Time	V _{DD} =-10V, R _L =15Ω, I _D =-5.0A, V _{GEN} =-10V, R _G =6Ω		18	30	ns
t _r				30	50	
t _{d(off)}	Turn-Off Time			100	150	
t _F				55	80	

Typical Performance Characteristics

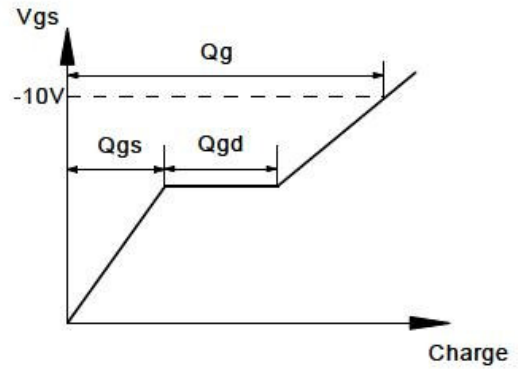
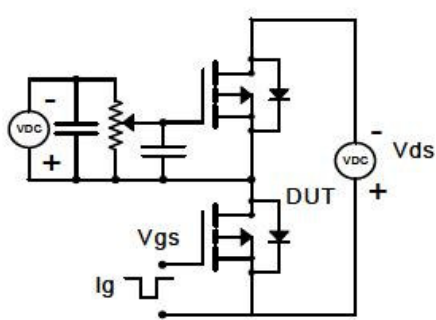


Typical Performance Characteristics (continue)

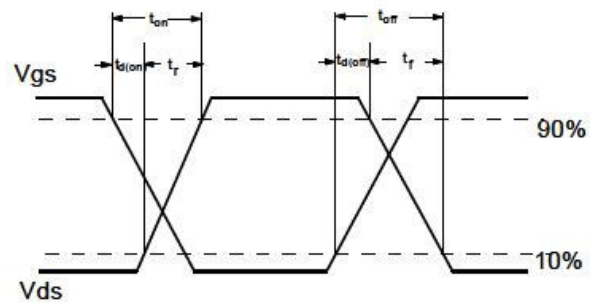
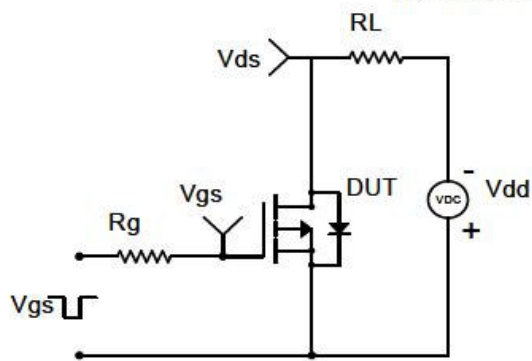


Typical Performance Characteristics (continue)

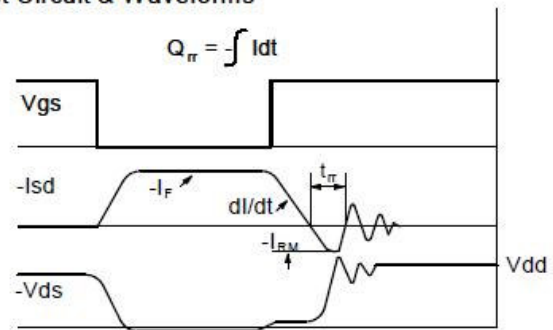
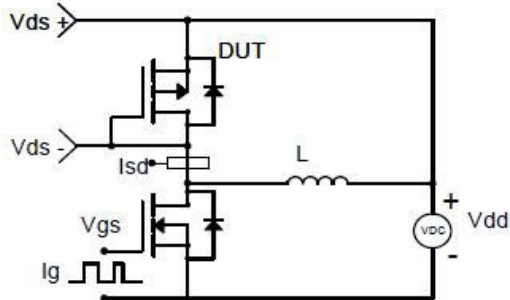
Gate Charge Test Circuit & Waveform



Resistive Switching Test Circuit & Waveforms

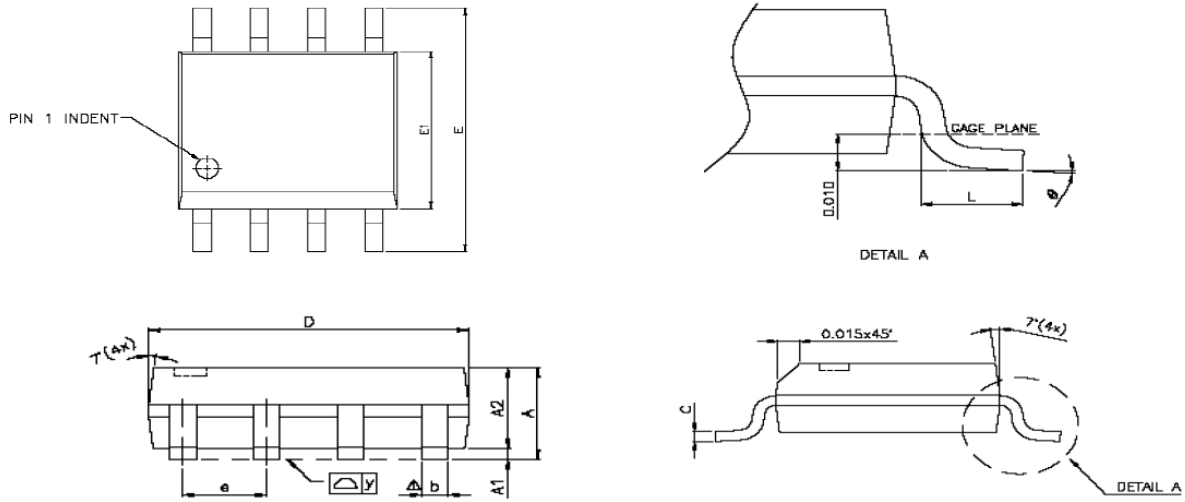


Diode Recovery Test Circuit & Waveforms



Package Dimension

SOP-8P PLASTIC PACKAGE




Dimensions



Symbol	Millimeters			Inches		
	Min	Nom	Max	Min	Nom	Max
A	1.47	1.60	1.73	0.058	0.063	0.068
A1	0.10	-	0.25	0.004	-	0.010
A2	-	1.45	-	-	0.057	-
b	0.33	0.41	0.51	0.013	0.016	0.020
C	0.19	0.20	0.25	0.0075	0.008	0.0098
D	4.80	4.85	4.95	0.189	0.191	0.195
E	5.80	6.00	6.20	0.228	0.236	0.244
E1	3.80	3.90	4.00	0.150	0.154	0.157
e	-	1.27	-	-	0.050	-
L	0.38	0.71	1.27	0.015	0.028	0.050
Δy	-	-	0.076	-	-	0.003
θ	0°	-	8°	0°	-	8°


NOTICE

Information furnished is believed to be accurate and reliable. However Globaltech Semiconductor assumes no responsibility for the consequences of use of such information nor for any infringement of patents or other rights of third parties, which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of Globaltech Semiconductor. Specifications mentioned in this publication are subject to change without notice. This publication supersedes and replaces all information without express written approval of Globaltech Semiconductor.

CONTACT US

GS Headquarter	
	4F.,No.43-1,Lane11,Sec.6,Minquan E.Rd Neihu District Taipei City 114, Taiwan (R.O.C)
	886-2-2657-9980
	886-2-2657-3630
	sales_twn@gs-power.com

Wu-Xi Branch	
	No.21 Changjiang Rd., WND, Wuxi, Jiangsu, China (INFO. &. TECH. Science Park Building A 210 Room)
	86-510-85217051
	86-510-85211238
	sales_cn@gs-power.com

RD Division	
	824 Bolton Drive Milpitas. CA. 95035
	1-408-457-0587